

## 1. General description

Dual common cathode power Schottky diode in TO252 (DPAK) plastic package.



## 2. Features and benefits

- High junction temperature up to 175 °C
- Low forward voltage drop, negligible switching losses
- High efficiency

## 3. Applications

- DC to DC converters
- Freewheeling diode
- OR-ing diode
- Switched mode power supply rectifier

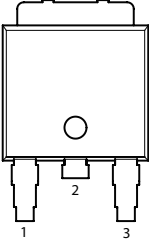
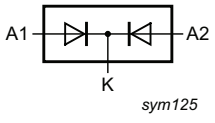
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes	Values			Unit
<b>Absolute maximum rating</b>							
$V_{RRM}$	repetitive peak reverse voltage			200			V
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 160$ °C; per diode; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>		5			A
$I_{O(AV)}$	average output current	$\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 159$ °C; both diodes conducting		10			A
Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
<b>Static characteristics</b>							
$V_F$	forward voltage	$I_F = 5$ A; $T_j = 25$ °C; per diode; <a href="#">Fig. 6</a>		-	0.83	0.93	V
$I_R$	reverse current	$V_R = 200$ V; $T_j = 25$ °C; per diode; <a href="#">Fig. 7</a> ; <a href="#">Fig. 8</a>		-	0.03	5	μA

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		 sym125
2	K	cathode		
3	A2	anode 2		
mb	K	mounting base; connected to cathode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WN3S10S200CDT	TO252	WN3S10S200CDTJ	Reel	2500	TO252d	07-Sep-2022

## 7. Marking

Table 4. Marking codes

Type number	Marking codes
WN3S10S200CDT	WN3S10S 200CDT

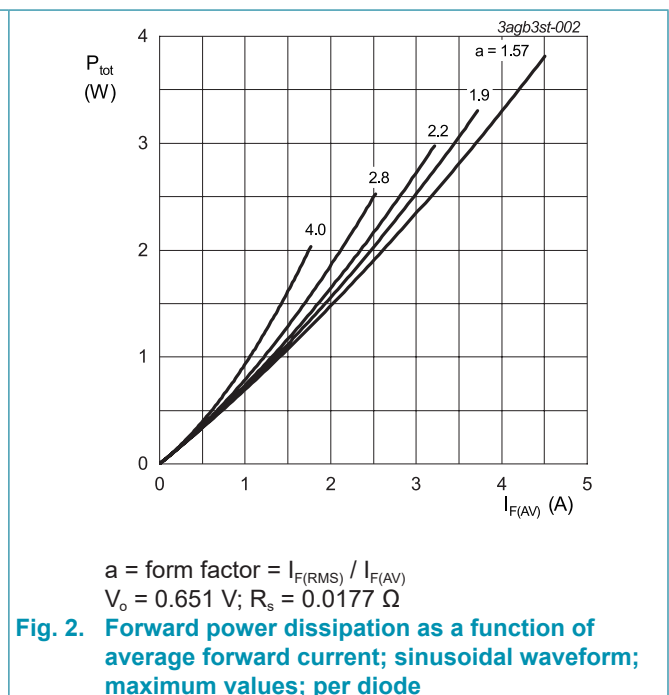
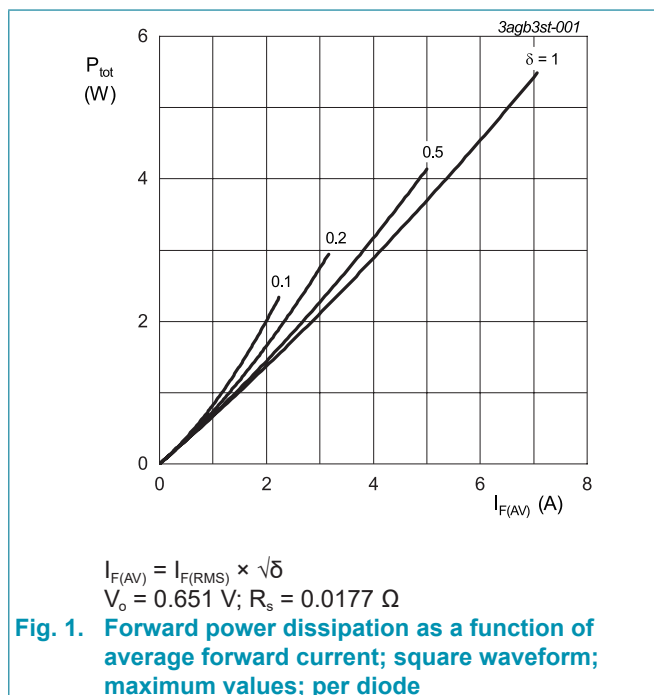
## 8. Limiting values

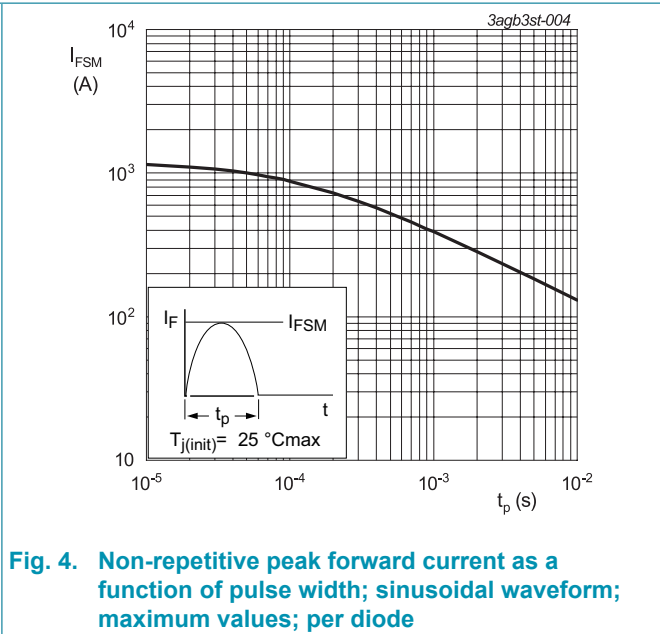
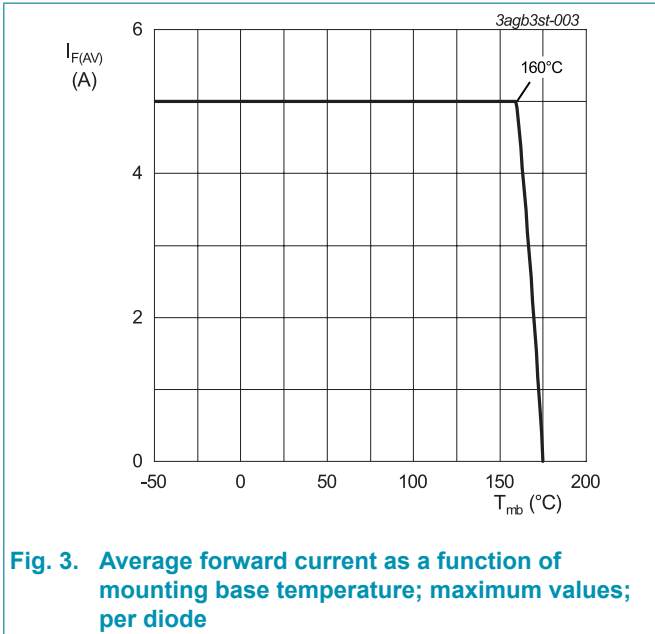
**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage			200	V
$V_{RWM}$	crest working reverse voltage			200	V
$V_R$	reverse voltage	DC		200	V
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 160\text{ }^\circ\text{C}$ ; per diode; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>		5	A
$I_{O(AV)}$	average output current	$\delta = 0.5$ ; square-wave pulse; $T_{mb} \leq 159\text{ }^\circ\text{C}$ ; both diodes conducting		10	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 10\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$ ; sine-wave pulse; per diode; <a href="#">Fig. 4</a>		130	A
		$t_p = 8.3\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ }^\circ\text{C}$ ; sine-wave pulse; per diode		143	A
$T_{stg}$	storage temperature			-40 to 175	$^\circ\text{C}$
$T_j$	junction temperature		[1]	-40 to 175	$^\circ\text{C}$

[1] The heat generated must be less than the thermal conductivity from Junction to Ambient:  $dP_{tot}/dT_j < 1/R_{th(j-a)}$





### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	per diode; <a href="#">Fig. 5</a>		-	-	3.7	K/W
		both diodes conducting		-	-	1.9	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air		-	50	-	K/W

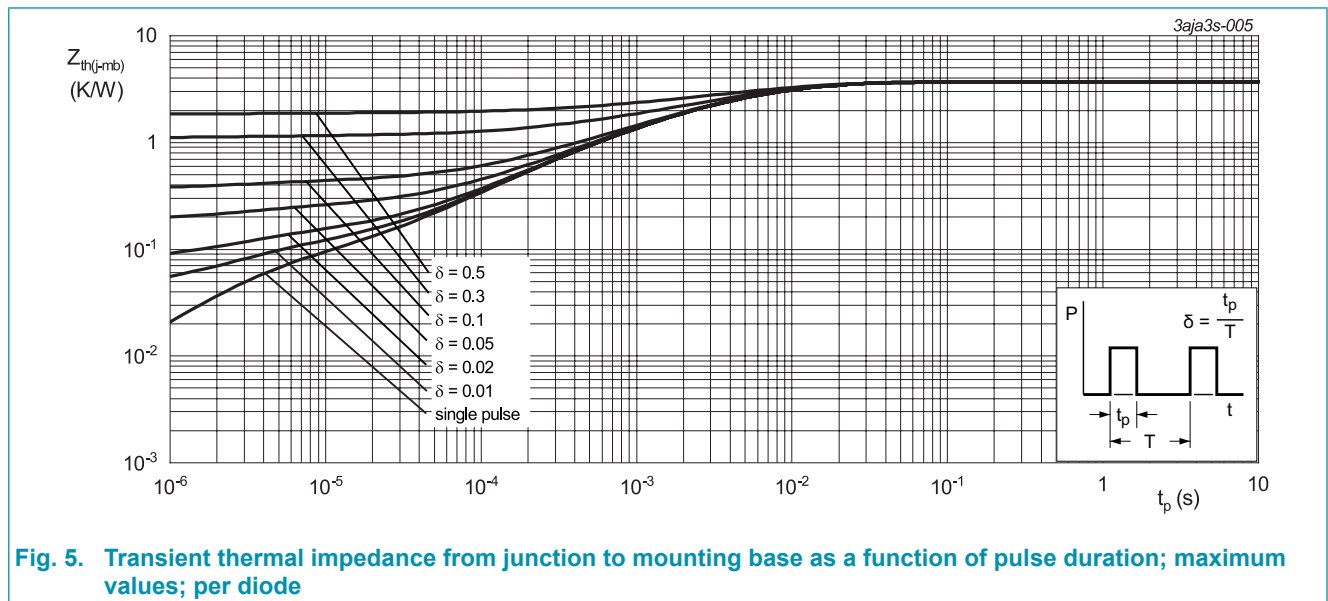
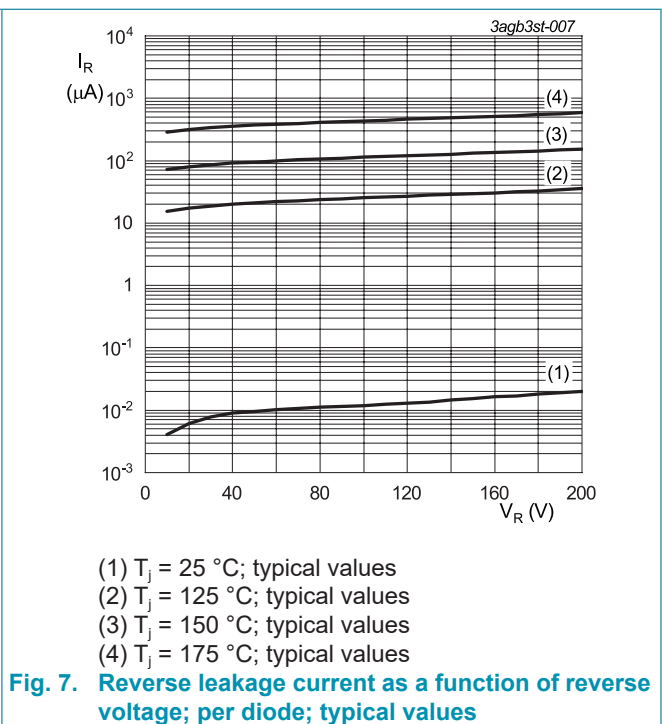
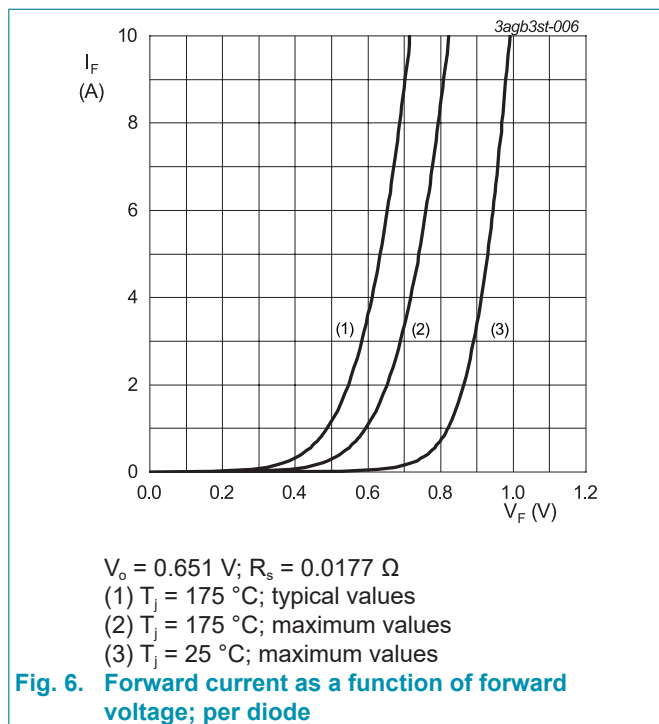


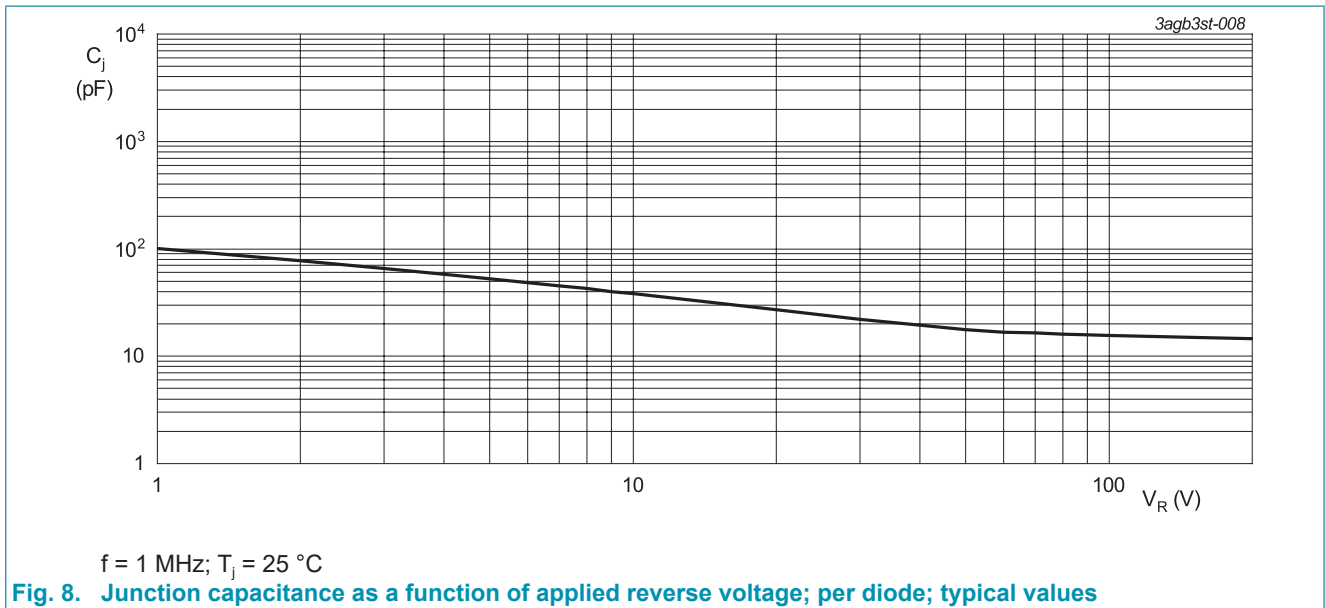
Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration; maximum values; per diode

### 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Typ	Max	Unit
<b>Static characteristics</b>							
$V_F$	forward voltage	$I_F = 5\text{ A}; T_j = 25\text{ }^\circ\text{C};$ per diode; <a href="#">Fig. 6</a>		-	0.83	0.93	V
		$I_F = 5\text{ A}; T_j = 125\text{ }^\circ\text{C};$ per diode; <a href="#">Fig. 6</a>		-	0.70	-	V
$I_R$	reverse current	$V_R = 200\text{ V}; T_j = 25\text{ }^\circ\text{C};$ per diode; <a href="#">Fig. 7; Fig. 8</a>		-	0.03	5	$\mu\text{A}$
		$V_R = 200\text{ V}; T_j = 125\text{ }^\circ\text{C};$ per diode; <a href="#">Fig. 7; Fig. 8</a>		-	0.04	-	mA

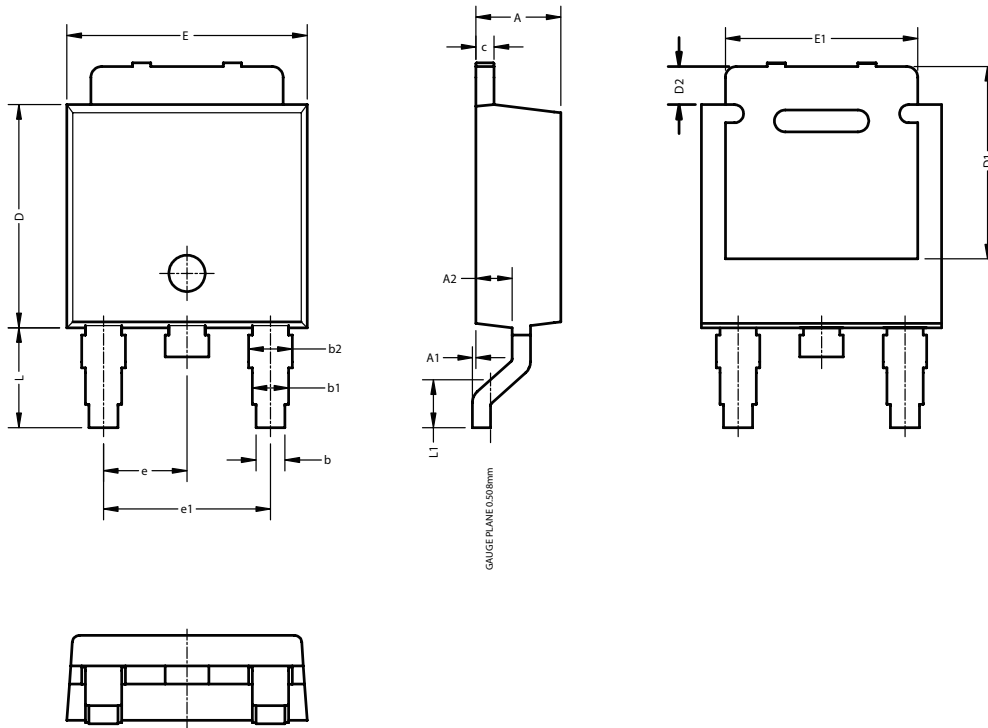




### 11. Package outline

Plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)

TO252



Note:

1. All dimensions do not include mold flash & gate remain and metal protrusion.

Unit	A	A1	A2	b	b1	b2	c	D	D1	D2	E	E1	e	e1	L	L1
min	2.16	0.00	0.90	0.70	0.86	1.06	0.46	5.97	5.05	0.98	6.45	5.20			2.60	1.25
nom													2.30	4.60		
max	2.41	0.10	1.10	0.90	1.11	1.32	0.58	6.22	5.35	1.18	6.75	5.40			2.90	1.65



## 12. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Date of release: 21 November 2022

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